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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
09/761,641	01/18/2001	Shunpci Yamazaki	740756-002249 6097 EXAMINER	
22204	7590 10/26/2005			
NIXON PEABODY, LLP 401 9TH STREET, NW SUITE 900 WASHINGTON, DC 20004-2128			BOOTH, RICHARD A	
			ART UNIT	PAPER NUMBER
			2812	
			DATE MAILED: 10/26/2005	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)				
	09/761,641	YAMAZAKI ET AL.				
Office Action Summary	Examiner	Art Unit				
	Richard A. Booth	2812				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply						
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.  - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.  - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).						
Status						
Responsive to communication(s) filed on <u>20 Seconds</u> This action is <b>FINAL</b> 2b) ☐ This      Since this application is in condition for alloware closed in accordance with the practice under Expression in the practice of the prac	action is non-final. nce except for formal matters, pro					
Disposition of Claims						
4) Claim(s) 1-3,6-14 and 19-48 is/are pending in to 4a) Of the above claim(s) is/are withdraw 5) Claim(s) is/are allowed.  6) Claim(s) 1-3,6-14 and 19-48 is/are rejected.  7) Claim(s) is/are objected to.  8) Claim(s) are subject to restriction and/or are subject to restriction and/or are subject to by the Examine 10) The drawing(s) filed on is/are: a) access Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct	vn from consideration.  r election requirement.  r.  epted or b) □ objected to by the I drawing(s) be held in abeyance. See	e 37 CFR 1.85(a).				
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.						
Priority under 35 U.S.C. § 119						
<ul> <li>12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).</li> <li>a) All b) Some * c) None of:</li> <li>1. Certified copies of the priority documents have been received.</li> <li>2. Certified copies of the priority documents have been received in Application No</li> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> </ul>						
Attachment(s)  1) Notice of References Cited (PTO-892)  2) Notice of Draftsperson's Patent Drawing Review (PTO-948)  3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal F 6) Other:					

### **DETAILED ACTION**

## Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

Claims 1-3, 6-14, and 19-43 are rejected under 35 U.S.C. 103(a) as being unpatentable over Yamazaki, U.S. Patent 4,727,044 in view of Silver, U.S. Patent 5,104,818 and further in view of Chang, U.S. Patent 5,064,775, Zhang et al., U.S. Patent 5,904,509, and Miyasaka, U.S. Patent 6,455,360..

Yamazaki shows the invention substantially as claimed including forming a semiconductor film 2 having an amorphous structure over a substrate 1; crystallizing the semiconductor film (see col. 6-lines 49-55), and wherein a concentration of carbon,

nitrogen, and oxygen are present in an amount less than 5 x 10<sup>18</sup> atoms/cm<sup>3</sup> (see col. 8lines 18-20).

Yamazaki fails to expressly disclose ion-doping an impurity element into a channel region, wherein said impurity element imparts p-type conductivity to said semiconductor film, wherein the concentration of said impurity element is 2 x 10<sup>17</sup> atoms/cm<sup>3</sup> after the step.

Silver shows the invention substantially as claimed including a method of manufacturing a semiconductor device comprising: ion-doping an impurity element into a channel region, wherein said impurity element imparts p-type conductivity to said semiconductor film (see fig. 1C), wherein the concentration of said impurity element is 2 x 10<sup>17</sup> atoms/cm<sup>3</sup> after the step (see figs. 1c-1f and col. 2-lines 29-54). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Yamazaki so as to implant the channel region as shown by Silver because such an implant is an effective way to control the threshold voltage of the transistor.

Yamazaki and Silver fail to expressly disclose ion-doping an impurity element into a channel region of the semiconductor film through the insulating film, with no mass separation performed in the ion-doping step and wherein said impurity element is doped by employing a source material gas comprising an impurity element diluted with hydrogen at a concentration of 0.5 to 5 percent.

Chang discloses introducing boron 36 into a semiconductor film so that the boron implanted region becomes part of a channel region (see fig. 2 and col. 4-line 55 to col.

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5-line 37), In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Yamazaki modified by Silver so as to implant boron into the channel region because this will allow for more independent control of the threshold voltage. Furthermore, Zhang et al. discloses performing plasma doping without mass separation and implanting these ions into a semiconductor film through an insulating film (see col. 8-line 59 to col. 9-line 2). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Yamazaki modified by Silver and Chang so as to conduct the implantation using plasma doping since plasma doping is shown to be a suitable method of injecting ions into a semiconductor. Moreover, Miyasaka discloses performing a doping step using diborane diluted with hydrogen at a concentration of 0.1 to 10% (see col. 22-lines 37-41). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the process of Yamazaki modified by Silver, Chang, and Zhang et al. so as to include a diborane gas diluted with hydrogen because Miyasaka shows this to be a suitable combination to form doped region in thin film structures.

Regarding the doping gases being used, official notice was taken regarding this fact in the office action mailed 10-10-02, and therefore this limitation is taken to be admitted prior art.

Claims 44-48 are rejected under 35 U.S.C. 103(a) as being unpatentable over Yamazaki, U.S. Patent 4,727,044 in view of Silver, U.S. Patent 5,104,818 and further in

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view of Chang, U.S. Patent 5,064,775, Zhang et al., U.S. Patent 5,904,509, and Miyasaka, U.S. Patent 6,455,360. as applied to claims 1-3, 6-14, and 19-43 above, and further in view of Wolf et al., "Silicon Processing for the VLSI Era Volume 1: Process Technology".

Yamazaki, Silver, Chang, Zhang et al., and Miyasaka are applied as above but do not expressly disclose wherein said ion-doping is performed through the insulating film. Wolf et al. discloses that commonly in order to reduce damage to the semiconductor surface, layers are deliberately added, for instance, silicon oxide layers (see page 323, "Implanting Through Surface Layers"). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to perform ion doping through an insulating film because this will reduce the damage to the substrate.

## Response to Arguments

Applicant's arguments filed 09/20/05 have been fully considered but they are not persuasive. In response to applicant's argument that none of the references recognize the problem with carbon, nitrogen, and oxygen incorporation with respect to ion doping and mass separation, the fact that applicant has recognized another advantage which would flow naturally from following the suggestion of the prior art cannot be the basis for patentability when the differences would otherwise be obvious. See *Ex parte Obiaya*, 227 USPQ 58, 60 (Bd. Pat. App. & Inter. 1985). Furthermore, no unexpected results have been shown with respect to the claimed features.

### Conclusion

THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Richard A. Booth whose telephone number is (571) 272-1668. The examiner can normally be reached on Monday-Thursday from 7:30-6:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Michael Lebentritt can be reached on (571) 272-1873. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Richard A. Booth Primary Examiner Art Unit 2812

October 24, 2005